

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7623757

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JU HAN LEE	02/18/2021
TAE YOON KIM	02/18/2021
KUNKYU KANG	02/18/2021
JUNHA JUNG	02/18/2021
RECEIVING PARTY DATA	
Name:	UNIVERSITY OF SEOUL INDUSTRY COOPERATION FOUNDATION
Street Address:	163, SEOULSIRIPDAE-RO, DONGDAEMUN-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	02504
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17979218
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	docketing@steinip.com
Correspondent Name:	STEIN IP LLC
Address Line 1:	1990 M STREET N.W.
Address Line 4:	WASHINGTON, D.C. 20036
ATTORNEY DOCKET NUMBER:	0864.1013C1
NAME OF SUBMITTER:	SUNGYEOP CHUNG
SIGNATURE:	/schung/
DATE SIGNED:	11/02/2022
Total Attachments: 2	
source=20OPA-0004US_Combined Declaration_Assignment#page1.tif	
source=20OPA-0004US_Combined Declaration_Assignment#page2.tif	

COMBINED DECLARATION/ASSIGNMENT FOR UTILITY/DESIGN PATENT APPLICATION

GATH OR DECLARATION

As a below named inventor, I hereby declare that:

This combined declaration and assignment is directed to the application entitled:

OPTICAL FIBER DEVICE FOR REMOVING CLADDING LIGHT, APPARATUS AND METHOD FOR ETCHING THE SAME

the specification of which is attached hereto, or was filed on _____ as United States Application Number (or PCT International Application Number) _____ and was amended on _____ (if applicable).
Any registered attorney of STEIN IP, LLC, 1990 M St., N.W., Suite 610, Washington, D.C. 20036 (202-216-9505), USPTO Customer Number 49,455, is hereby authorized to insert the specified data into the above paragraph, when known.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

IN CONSIDERATION of good and valuable consideration paid to me, an undersigned inventor, by

UNIVERSITY OF SEOUL INDUSTRY COOPERATION FOUNDATION

163, Seoulsiripdae-ro, Dongdaemun-gu, Seoul, Republic of Korea 02504


(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, I hereby sell, assign and transfer to ASSIGNEE the entire and exclusive right, title and interest to the above-identified application and the claimed invention therein, and any continuation, division, renewal, substitute, reissue or reexamination application based thereon (collectively, hereinafter, "said application(s)"); and all Letters Patent of the United States granted on said application(s), for the full term or terms for which the said Letters Patent may be granted and including any extensions thereof (collectively, hereinafter, "said Letters Patent").

I agree, when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent, in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

I covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

IN WITNESS WHEREOF, I have affixed my signature on the date beneath:

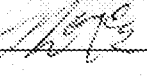
Full name of sole/first inventor Ju Han LEE

Inventor's Signature  | Date Executed 12th Feb 2021

Inventor's Mailing Address #301-201, 58, Saimdang-ro 23-gil, Seocho-gu, Seoul, Republic of Korea 06636

Inventor's Residence #301-201, 234, 58, Saimdang-ro 23-gil, Seocho-gu, Seoul, Republic of Korea 06636

Full name of second inventor Tae Yoon KIM

Inventor's Signature  | Date Executed 18th Feb 2021

Inventor's Mailing Address #102-1201, 20, Saik-ro 8-gil, Jongno-gu, Seoul, Republic of Korea 03174

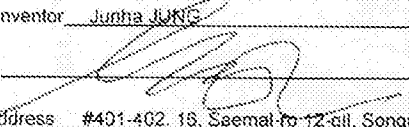
Inventor's Residence #102-1201, 20, Saik-ro 8-gil, Jongno-gu, Seoul, Republic of Korea 03174

Full name of third inventor Kunhyu KANG

Inventor's Signature 김진규 Date Executed 18th Feb 2021

Inventor's Mailing Address #304-202, 234, Suraksan-ro, Nowon-gu, Seoul, Republic of Korea 01615
Inventor's Residence #304-202, 234, Suraksan-ro, Nowon-gu, Seoul, Republic of Korea 01615

Full name of fourth inventor Junha JUNG

Inventor's Signature  Date Executed 18th Feb 2021

Inventor's Mailing Address #401-402, 16, Saemal-ro 12-gil, Songpa-gu, Seoul, Republic of Korea 05811
Inventor's Residence #401-402, 16, Saemal-ro 12-gil, Songpa-gu, Seoul, Republic of Korea 05811